



Intel® Core™ i3-2330E Processor (3M Cache, 2.20 GHz)

SPECIFICATIONS

All

Essentials

Memory Specifications

Graphics Specifications

Expansion Options

Package Specifications

Advanced Technologies

COMPATIBLE PRODUCTS

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Specifications


Essentials

| | |
|----------------------------|----------|
| Status | Launched |
| Launch Date | Q2'11 |
| Processor Number | i3-2330E |
| # of Cores | 2 |
| # of Threads | 4 |
| Clock Speed | 2.2 GHz |
| Intel® Smart Cache | 3 MB |
| DMI | 5 GT/s |
| Instruction Set | 64-bit |
| Instruction Set Extensions | AVX |
| Embedded Options Available | Yes |
| Lithography | 32 nm |
| Max TDP | 35 W |

Memory Specifications

| | |
|--|--|
| Max Memory Size (dependent on memory type) | 16 GB |
| Memory Types | DDR3-1066/1333 |
| # of Memory Channels | 2 |
| Max Memory Bandwidth | 21.3 GB/s |
| ECC Memory Supported |  No |

Graphics Specifications

| | |
|--|---|
| Processor Graphics |  Intel® HD Graphics 3000 |
| Graphics Base Frequency | 650 MHz |
| Graphics Max Dynamic Frequency | 1.05 GHz |
| Graphics Output | eDP/DP /HDMI/SDVO/CRT |
| Intel® Quick Sync Video | Yes |
| Intel® InTru™ 3D Technology, | Yes |
| Intel® Wireless Display | Yes |
| Intel® Flexible Display Interface (Intel® FDI) | Yes |
| Intel® Clear Video HD Technology | Yes |
| Dual Display Capable | Yes |

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ADDITIONAL INFORMATION

PCN/MDDS INFORMATION

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| Expansion Options | |
|--------------------------------|--|
| PCI Express Revision | 2.0 |
| PCI Express Configurations |  1x16 1x4, 2x8 1x4, 1x8 3x4 |
| Package Specifications | |
| T JUNCTION | 100 C |
| Package Size | 37.5mm x 37.5mm (rPGA988) |
| Graphics and IMC Lithography | 32 nm |
| Sockets Supported | FCPGA988 |
| Halogen Free Options Available | Yes |

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

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Hyper-Threading Technology (HT Technology) requires a computer system with an Intel® processor supporting HT Technology and an HT Technology enabled chipset, BIOS and operating system. Performance will vary depending on the specific hardware and software you use. See www.intel.com/products/ht/hyperthreading_more.htm for more information including details on which processors support HT Technology.

Intel® Virtualization Technology requires a computer system with a processor, chipset, BIOS, virtual machine monitor (VMM) and for some uses, certain platform software, enabled for it. Functionality, performance or other benefit will vary depending on hardware and software configurations. Intel Virtualization Technology-enabled VMM applications are currently in development.

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Halogen Free implies the following:

Bromine and/or chlorine in materials that may be used during processing, but do not remain within the final product are not included in this definition. The halogens fluorine (F), iodine (I), and astatine (At) are not restricted by this standard.

"BFR/CFR and PVC-Free" Definition :

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Although the elemental analysis for Br and Cl in homogeneous materials can be performed by any analytical method with sufficient sensitivity and selectivity, the presence or absence of BFRs, CFRs or PVC must be verified by any acceptable analytical techniques that allow for the unequivocal identification of the specific Br or Cl compounds, or by appropriate material declarations agreed to between customer and supplier.

Max Turbo Frequency refers to the maximum single-core frequency that can be achieved with Intel® Turbo Boost Technology, which requires a PC with a processor with Intel Turbo Boost Technology capability. Intel Turbo Boost Technology performance varies depending on hardware, software, and overall system configuration. Check with your PC manufacturer on whether your system delivers Intel Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

Advanced Technologies

| | |
|--|-----|
| Intel® Turbo Boost Technology | No |
| Intel® vPro Technology | No |
| Intel® Hyper-Threading Technology | Yes |
| Intel® Virtualization Technology (VT-x) | Yes |
| Intel® Virtualization Technology for Directed I/O (VT-d) | No |
| Intel® Trusted Execution Technology | No |
| AES New Instructions | No |
| Intel® 64 | Yes |
| Intel® Anti-Theft Technology | Yes |
| Intel® My WiFi Technology | Yes |
| 4G WiMAX Wireless Technology | Yes |
| Idle States | Yes |
| Enhanced Intel SpeedStep® Technology | Yes |
| Intel® Demand Based Switching | No |
| Thermal Monitoring Technologies | Yes |
| Intel® Fast Memory Access | Yes |
| Intel® Flex Memory Access | Yes |
| Execute Disable Bit | Yes |

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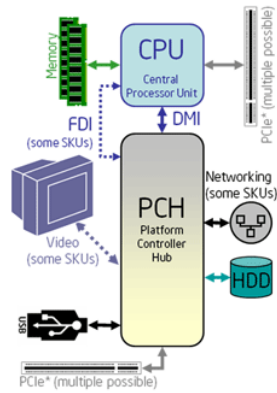
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ORDERING AND SPEC INFORMATION

Ordering and Spec Information

Intel® Core™ i3-2330E Processor (3M Cache, 2.20 GHz) FC-PGA10, Tray

| Socket | Step | Step TDP | Ordering Code | Spec Code | Halogen Free | VT-x |
|----------|------|----------|-----------------|-----------|--------------|------|
| FCPGA988 | D2 | 35 W | FF8062700849000 | SR02V | Yes | Yes |

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